ST0343-10-N01-B

Amphenol

Datasheet

0.69-0.96GHz & 1.7-2.7GHz

Chip antenna

Features:

High performing full 4G LTE band antenna with SMT mounting on PCB.

Applications:

- Telematics Control Unit (TCU)
- HD Video over 4G LTE
- First Responder and Emergency Services
- Intelligent Transport Systems
- Internet of Things (IoT)
- High Definition Video Broadcast Systems
- Wireless 4G LTE M2M Devices
- Medical Devices
- MSL 3



 $35 \times 5 \times 4 \text{ mm}$

Chip Antenna

Electrical Specifications							
Antenna Characteristics							
Antenna Type	Radiation Pattern		Polarization		Max. Input Power		Impedance
Chip Antenna	Omni		Linear		5W		50Ω
Frequency (GHz)		0.698~0.96		1.71~2.17		2.3~2.69	
Return Loss (dB)		< -6			< -6		< -6
Peak Gain (dBi)		3.5			2.8		5.6
Average Gain (dB)		-2.2			-2.9		-1.2
Efficiency (%)		60			51		76

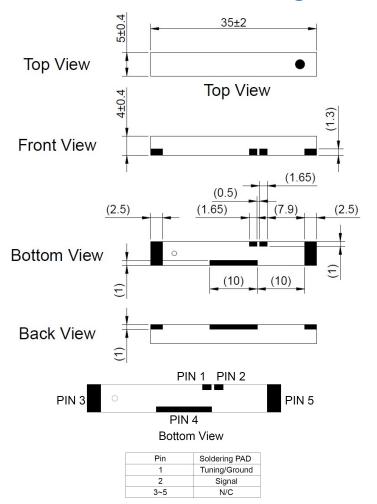


Mechanical Specifications				
Mechanical Mechanical				
Dimension (mm)	35.0 × 5.0 × 4.0			
Material	Ceramic			
Weight (g)	2.3			

Environmental				
Temperature Range (°C)	-40 to 85			
Humidity	Non-condensing 65°C 95% RH			

RoHS Compliant

Mechanical Drawing



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Unit: mm

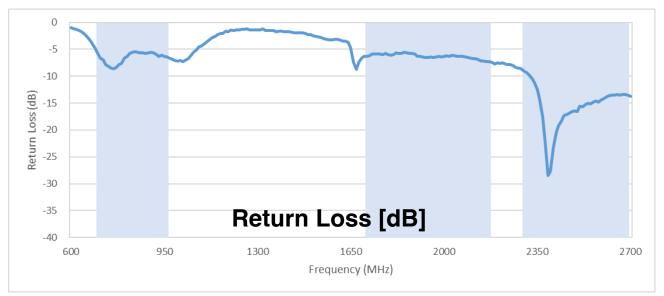
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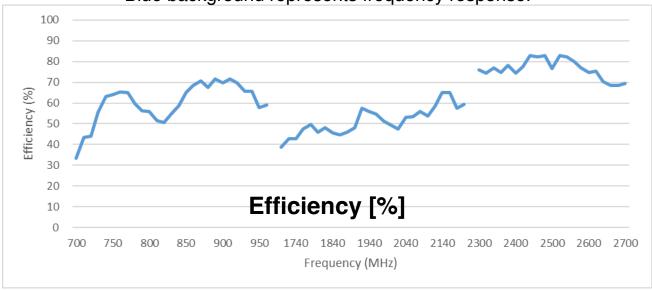
Antenna Testing Includes Evaluation Board



Test setup, measurement performed in 3D anechoic chamber.

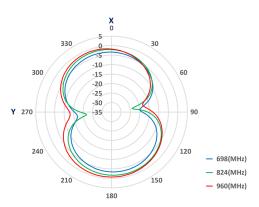


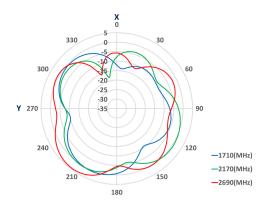
Blue background represents frequency response.



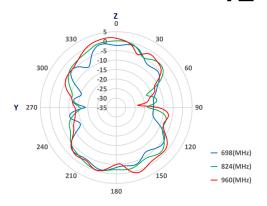
Radiation Pattern - Free Space

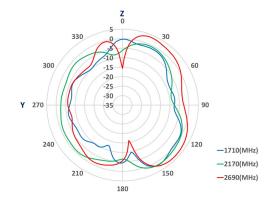
XY - Plane



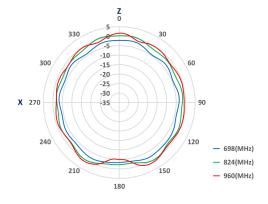


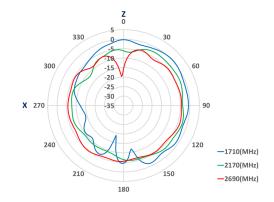
YZ - Plane



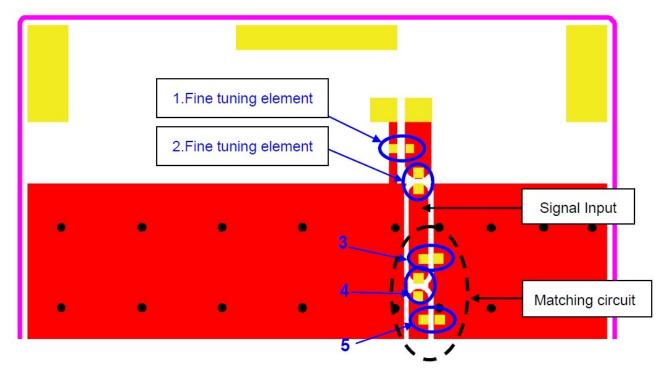


XZ - Plane





Matching Circuit Design

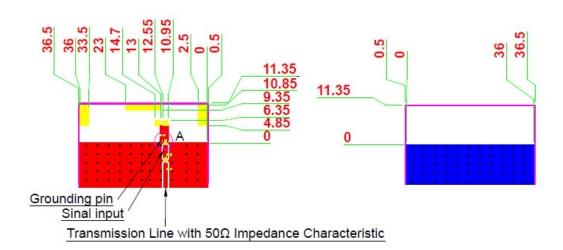


- * To make the antenna have this resonance must be matched with the matching circuit.
- * The matching component may be slightly different than that shown depending on the distance to the ground plane, the dielectric constant of the PCB, and PCB material thickness.

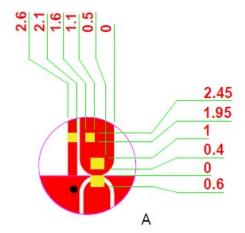
Circuit Matching Components					
Circuit Symbol	Size	Description			
1. Fine tuning element	0402	6.8 nH Inductance			
2. Fine tuning element	0402	3.9 pF Capacitor			
3	0402	None			
4	0402	0 Ohm Resistance			
5	0402	None			

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Clearance Area Design



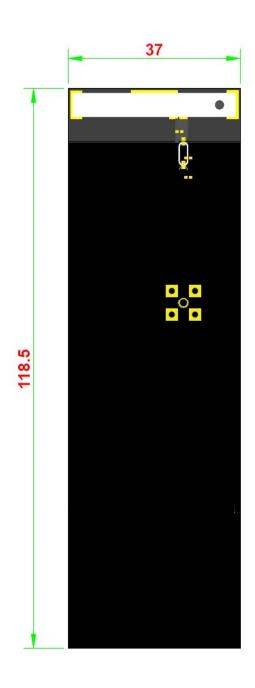
Top View Bottom View

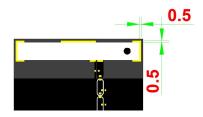




Evaluation Board

Unit: mm



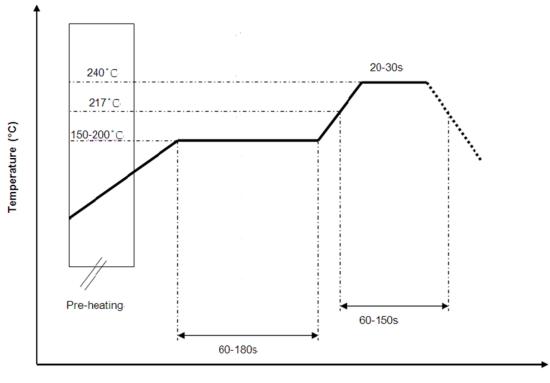


Base Material : FR-4, T=1.0

Recommended Reflow Temperature Profile

Recommended solder paste alloy:

SAC305 (Sn96.5 /Ag3 /Cu0.5) Lead Free solder paste



4G LTE

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Revisions						
Rev.	Description	Date	ECN	Approval		
Α	Initial Release	2023-02-17	ST0343-10-N01-B-RA00	ATC		

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